

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Sachi KIKUNO</td> <td>07/26/2012</td> </tr> <tr> <td>Atsushi HEGURI</td> <td>07/26/2012</td> </tr> <tr> <td>Masayoshi HANDA</td> <td>07/26/2012</td> </tr> <tr> <td>Nobuhiro MAEDA</td> <td>07/26/2012</td> </tr> </tbody> </table>		Name	Execution Date	Sachi KIKUNO	07/26/2012	Atsushi HEGURI	07/26/2012	Masayoshi HANDA	07/26/2012	Nobuhiro MAEDA	07/26/2012
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<table border="1"> <tr> <td>Name:</td> <td>Sumitomo Seika Chemicals Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>346-1, Miyanishi, Harima-cho, Kako-gun</td> </tr> <tr> <td>City:</td> <td>Hyogo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>675-0145</td> </tr> </table>		Name:	Sumitomo Seika Chemicals Co., Ltd.	Street Address:	346-1, Miyanishi, Harima-cho, Kako-gun	City:	Hyogo	State/Country:	JAPAN	Postal Code:	675-0145
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CORRESPONDENCE DATA											
<p>Fax Number: 6124553801 Phone: 612-455-3800 Email: pkerkhove@hsml.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Hamre, Schumann, Mueller & Larson, P.C. Address Line 1: P. O. Box 2902 Address Line 4: Minneapolis, MINNESOTA 55402</p>											
ATTORNEY DOCKET NUMBER:	20162.0054USWO										
NAME OF SUBMITTER:	Douglas P. Mueller										
Total Attachments: 2 source=Assignment_0054#page1.tif source=Assignment_0054#page2.tif											

CH \$40.00 13510522

Docket No. 20162.54USWO

ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. Sachi KIKUNO residing at 4025-E-1, Mikkaichi, Kurobe-shi, Toyama 938-0031, Japan and a citizen of Japan
2. Atsushi HEGURI residing at c/o Sumitomo Seika Chemicals Co., Ltd., 1, Irifune-cho, Shikama-ku, Himeji-shi, Hyogo 672-8076, Japan and a citizen of Japan
3. Masayoshi HANDA residing at c/o Sumitomo Seika Chemicals Co., Ltd., 1, Irifune-cho, Shikama-ku, Himeji-shi, Hyogo 672-8076, Japan and a citizen of Japan
4. Nobuhiro MAEDA residing at c/o Sumitomo Seika Chemicals Co., Ltd., 1, Irifune-cho, Shikama-ku, Himeji-shi, Hyogo 672-8076, Japan and a citizen of Japan

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on _____, entitled **PROCESS FOR PRODUCTION OF WATER-ABSORBING RESIN PARTICLES, WATER-ABSORBING RESIN PARTICLES, WATER-STOPPING MATERIAL, AND ABSORBENT ARTICLE**, and which has been given application serial number _____;

and

WHEREAS Sumitomo Seika Chemicals Co., Ltd. (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at 346-1, Miyanishi, Harima-cho, Kako-gun, Hyogo 675-0145, Japan wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of

the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Sachi Kikuno

1. Sachi KIKUNO

JUL. 26. 2012

Date

Atsushi HEGURI

2. Atsushi HEGURI

JUL. 26. 2012

Date

Masayoshi HANDA

3. Masayoshi HANDA

JUL. 26. 2012

Date

Nobuhiro MAEDA

4. Nobuhiro MAEDA

JUL. 26. 2012

Date